



## N-CHANNEL MOSFET

### Qualified per MIL-PRF-19500/557

Qualified Levels:  
JAN, JANTX, JANTXV  
and JANS\*

#### DESCRIPTION

This family of switching transistors is military qualified up to the JANTXV level for high-reliability applications. The 2N6798 part number is also qualified to the JANS level. These devices are also available in a low profile U-18 LCC surface mount package. Microsemi also offers numerous other transistor products to meet higher and lower power ratings with various switching speed requirements in both through-hole and surface-mount packages.

**Important:** For the latest information, visit our website <http://www.microsemi.com>.

#### FEATURES

- JEDEC registered 2N6796, 2N6798, 2N6800 and 2N6802 number series.
- JAN, JANTX, and JANTXV qualifications are available per MIL-PRF-19500/557.  
\*JANS qualification is available on 2N6798 only.  
(See [part nomenclature](#) for all available options.)
- RoHS compliant versions available (commercial grade only).

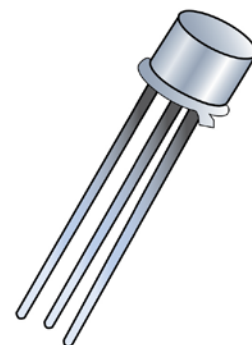
#### APPLICATIONS / BENEFITS

- Lightweight top-hat design with flexible terminals offers a variety of mounting flexibility.
- Military and other high-reliability applications.

#### MAXIMUM RATINGS @ $T_A = +25^\circ\text{C}$ unless otherwise stated

| Parameters / Test Conditions                                                                          | Symbol            | Value                    | Unit               |
|-------------------------------------------------------------------------------------------------------|-------------------|--------------------------|--------------------|
| Operating & Storage Junction Temperature Range                                                        | $T_J$ & $T_{stg}$ | -55 to +150              | $^\circ\text{C}$   |
| Thermal Resistance Junction-to-Case                                                                   | $R_{\theta JC}$   | 5.0                      | $^\circ\text{C/W}$ |
| Total Power Dissipation<br>@ $T_A = +25^\circ\text{C}$<br>@ $T_C = +25^\circ\text{C}$ <sup>(1)</sup>  | $P_T$             | 0.8<br>25                | W                  |
| Drain-Source Voltage, dc<br>2N6796<br>2N6798<br>2N6800<br>2N6802                                      | $V_{DS}$          | 100<br>200<br>400<br>500 | V                  |
| Gate-Source Voltage, dc                                                                               | $V_{GS}$          | $\pm 20$                 | V                  |
| Drain Current, dc @ $T_C = +25^\circ\text{C}$ <sup>(2)</sup><br>2N6796<br>2N6798<br>2N6800<br>2N6802  | $I_{D1}$          | 8.0<br>5.5<br>3.0<br>2.5 | A                  |
| Drain Current, dc @ $T_C = +100^\circ\text{C}$ <sup>(2)</sup><br>2N6796<br>2N6798<br>2N6800<br>2N6802 | $I_{D2}$          | 5.0<br>3.5<br>2.0<br>1.5 | A                  |
| Off-State Current (Peak Total Value) <sup>(3)</sup><br>2N6796<br>2N6798<br>2N6800<br>2N6802           | $I_{DM}$          | 32<br>22<br>14<br>11     | A (pk)             |
| Source Current<br>2N6796<br>2N6798<br>2N6800<br>2N6802                                                | $I_S$             | 8.0<br>5.5<br>3.0<br>2.5 | A                  |

See notes on next page.



**TO-205AF (TO-39)  
Package**

Also available in:

#### **U-18 LCC package**

(surface mount)  
2N6796U, 2N6798U,  
2N6800U & 2N6802U

#### **MSC – Lawrence**

6 Lake Street,  
Lawrence, MA 01841  
Tel: 1-800-446-1158 or  
(978) 620-2600  
Fax: (978) 689-0803

#### **MSC – Ireland**

Gort Road Business Park,  
Ennis, Co. Clare, Ireland  
Tel: +353 (0) 65 6840044  
Fax: +353 (0) 65 6822298

**Website:**

[www.microsemi.com](http://www.microsemi.com)

- Notes:**
1. Derate linearly 0.2 W/°C for  $T_C > +25\text{ }^{\circ}\text{C}$ .
  2. The following formula derives the maximum theoretical  $I_D$  limit.  $I_D$  is also limited by package and internal wires and may be limited due to pin diameter.

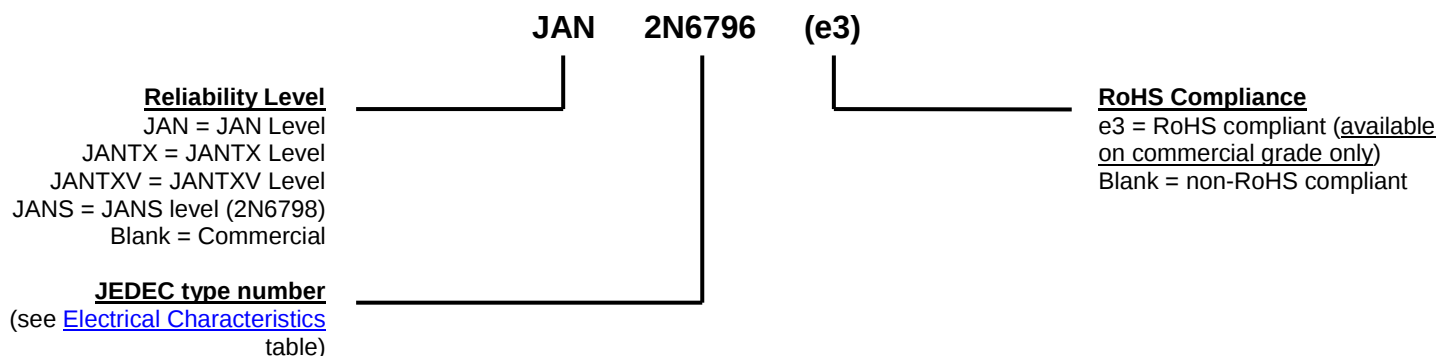
$$I_D = \sqrt{\frac{T_J(\text{max}) - T_C}{R_{\theta JC} \times R_{DS(on)} @ T_J(\text{max})}}$$

3.  $I_{DM} = 4 \times I_{D1}$  as calculated in note 2.

### MECHANICAL and PACKAGING

- CASE: Hermetically sealed, kovar base, nickel cap.
- TERMINALS: Tin/lead solder dip nickel plate or RoHS compliant pure tin plate (commercial grade only).
- MARKING: Part number, date code, manufacturer's ID.
- WEIGHT: Approximately 1.064 grams.
- See [Package Dimensions](#) on last page.

### PART NOMENCLATURE



### SYMBOLS & DEFINITIONS

| Symbol   | Definition                                                                                 |
|----------|--------------------------------------------------------------------------------------------|
| $di/dt$  | Rate of change of diode current while in reverse-recovery mode, recorded as maximum value. |
| $I_F$    | Forward current                                                                            |
| $R_G$    | Gate drive impedance                                                                       |
| $V_{DD}$ | Drain supply voltage                                                                       |
| $V_{DS}$ | Drain source voltage, dc                                                                   |
| $V_{GS}$ | Gate source voltage, dc                                                                    |

**ELECTRICAL CHARACTERISTICS @  $T_A = +25^\circ\text{C}$ , unless otherwise noted**

| Parameters / Test Conditions                                                                                                                                                                                                                                                                                         |                                      | Symbol                                          | Min.                     | Max.                             | Unit          |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------|-------------------------------------------------|--------------------------|----------------------------------|---------------|
| <b>OFF CHARACTERISTICS</b>                                                                                                                                                                                                                                                                                           |                                      |                                                 |                          |                                  |               |
| Drain-Source Breakdown Voltage<br>$V_{GS} = 0\text{ V}, I_D = 1.0\text{ mA}$                                                                                                                                                                                                                                         | 2N6796<br>2N6798<br>2N6800<br>2N6802 | $V_{(BR)DSS}$                                   | 100<br>200<br>400<br>500 |                                  | V             |
| Gate-Source Voltage (Threshold)<br>$V_{DS} \geq V_{GS}, I_D = 0.25\text{ mA}$<br>$V_{DS} \geq V_{GS}, I_D = 0.25\text{ mA}, T_J = +125^\circ\text{C}$<br>$V_{DS} \geq V_{GS}, I_D = 0.25\text{ mA}, T_J = -55^\circ\text{C}$                                                                                         |                                      | $V_{GS(th)1}$<br>$V_{GS(th)2}$<br>$V_{GS(th)3}$ | 2.0<br>1.0               | 4.0<br>5.0                       | V             |
| Gate Current<br>$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}$<br>$V_{GS} = \pm 20\text{ V}, V_{DS} = 0\text{ V}, T_J = +125^\circ\text{C}$                                                                                                                                                                         |                                      | $I_{GSS1}$<br>$I_{GSS2}$                        |                          | $\pm 100$<br>$\pm 200$           | nA            |
| Drain Current<br>$V_{GS} = 0\text{ V}, V_{DS} = 80\text{ V}$<br>$V_{GS} = 0\text{ V}, V_{DS} = 160\text{ V}$<br>$V_{GS} = 0\text{ V}, V_{DS} = 320\text{ V}$<br>$V_{GS} = 0\text{ V}, V_{DS} = 400\text{ V}$                                                                                                         | 2N6796<br>2N6798<br>2N6800<br>2N6802 | $I_{DSS1}$                                      |                          | 25                               | $\mu\text{A}$ |
| Drain Current<br>$V_{GS} = 0\text{ V}, V_{DS} = 80\text{ V}, T_J = +125^\circ\text{C}$<br>$V_{GS} = 0\text{ V}, V_{DS} = 160\text{ V}, T_J = +125^\circ\text{C}$<br>$V_{GS} = 0\text{ V}, V_{DS} = 320\text{ V}, T_J = +125^\circ\text{C}$<br>$V_{GS} = 0\text{ V}, V_{DS} = 400\text{ V}, T_J = +125^\circ\text{C}$ | 2N6796<br>2N6798<br>2N6800<br>2N6802 | $I_{DSS2}$                                      |                          | 0.25                             | mA            |
| Static Drain-Source On-State Resistance<br>$V_{GS} = 10\text{ V}, I_D = 5.0\text{ A pulsed}$<br>$V_{GS} = 10\text{ V}, I_D = 3.5\text{ A pulsed}$<br>$V_{GS} = 10\text{ V}, I_D = 2.0\text{ A pulsed}$<br>$V_{GS} = 10\text{ V}, I_D = 1.5\text{ A pulsed}$                                                          | 2N6796<br>2N6798<br>2N6800<br>2N6802 | $r_{DS(on)1}$                                   |                          | 0.18<br>0.40<br>1.00<br>1.50     | $\Omega$      |
| Static Drain-Source On-State Resistance<br>$V_{GS} = 10\text{ V}, I_D = 8.0\text{ A pulsed}$<br>$V_{GS} = 10\text{ V}, I_D = 5.5\text{ A pulsed}$<br>$V_{GS} = 10\text{ V}, I_D = 3.0\text{ A pulsed}$<br>$V_{GS} = 10\text{ V}, I_D = 2.5\text{ A pulsed}$                                                          | 2N6796<br>2N6798<br>2N6800<br>2N6802 | $r_{DS(on)2}$                                   |                          | 0.195<br>0.420<br>1.100<br>1.600 | $\Omega$      |
| Static Drain-Source On-State Resistance<br>$T_J = +125^\circ\text{C}$<br>$V_{GS} = 10\text{ V}, I_D = 5.0\text{ A pulsed}$<br>$V_{GS} = 10\text{ V}, I_D = 3.5\text{ A pulsed}$<br>$V_{GS} = 10\text{ V}, I_D = 2.0\text{ A pulsed}$<br>$V_{GS} = 10\text{ V}, I_D = 1.5\text{ A pulsed}$                            | 2N6796<br>2N6798<br>2N6800<br>2N6802 | $r_{DS(on)3}$                                   |                          | 0.35<br>0.75<br>2.40<br>3.50     | $\Omega$      |
| Diode Forward Voltage<br>$V_{GS} = 0\text{ V}, I_D = 8.0\text{ A pulsed}$<br>$V_{GS} = 0\text{ V}, I_D = 5.5\text{ A pulsed}$<br>$V_{GS} = 0\text{ V}, I_D = 3.0\text{ A pulsed}$<br>$V_{GS} = 0\text{ V}, I_D = 2.5\text{ A pulsed}$                                                                                | 2N6796<br>2N6798<br>2N6800<br>2N6802 | $V_{SD}$                                        |                          | 1.5<br>1.4<br>1.4<br>1.4         | V             |

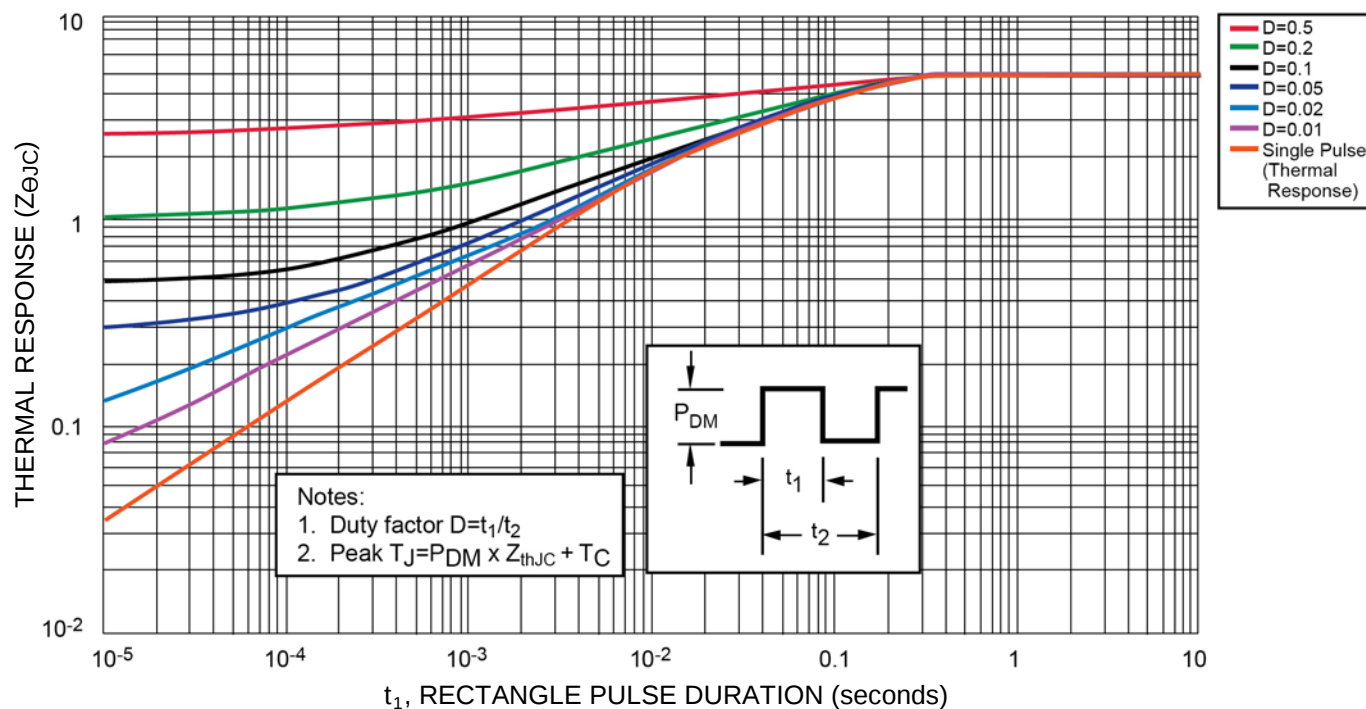
**ELECTRICAL CHARACTERISTICS @  $T_A = +25\text{ }^{\circ}\text{C}$ , unless otherwise noted (continued)**
**DYNAMIC CHARACTERISTICS**

| Parameters / Test Conditions                                            | Symbol      | Min. | Max.  | Unit |
|-------------------------------------------------------------------------|-------------|------|-------|------|
| <b>Gate Charge:</b>                                                     |             |      |       |      |
| On-State Gate Charge                                                    | $Q_{g(on)}$ |      |       |      |
| $V_{GS} = 10\text{ V}, I_D = 8.0\text{ A}, V_{DS} = 50\text{ V}$ 2N6796 |             |      | 28.51 | nC   |
| $V_{GS} = 10\text{ V}, I_D = 5.5\text{ A}, V_{DS} = 50\text{ V}$ 2N6798 |             |      | 42.07 |      |
| $V_{GS} = 10\text{ V}, I_D = 3.0\text{ A}, V_{DS} = 50\text{ V}$ 2N6800 |             |      | 34.75 |      |
| $V_{GS} = 10\text{ V}, I_D = 2.5\text{ A}, V_{DS} = 50\text{ V}$ 2N6802 |             |      | 33.00 |      |
| Gate to Source Charge                                                   | $Q_{gs}$    |      |       |      |
| $V_{GS} = 10\text{ V}, I_D = 8.0\text{ A}, V_{DS} = 50\text{ V}$ 2N6796 |             |      | 6.34  | nC   |
| $V_{GS} = 10\text{ V}, I_D = 5.5\text{ A}, V_{DS} = 50\text{ V}$ 2N6798 |             |      | 5.29  |      |
| $V_{GS} = 10\text{ V}, I_D = 3.0\text{ A}, V_{DS} = 50\text{ V}$ 2N6800 |             |      | 5.75  |      |
| $V_{GS} = 10\text{ V}, I_D = 2.5\text{ A}, V_{DS} = 50\text{ V}$ 2N6802 |             |      | 4.46  |      |
| Gate to Drain Charge                                                    | $Q_{gd}$    |      |       |      |
| $V_{GS} = 10\text{ V}, I_D = 8.0\text{ A}, V_{DS} = 50\text{ V}$ 2N6796 |             |      | 16.59 | nC   |
| $V_{GS} = 10\text{ V}, I_D = 5.5\text{ A}, V_{DS} = 50\text{ V}$ 2N6798 |             |      | 28.11 |      |
| $V_{GS} = 10\text{ V}, I_D = 3.0\text{ A}, V_{DS} = 50\text{ V}$ 2N6800 |             |      | 16.59 |      |
| $V_{GS} = 10\text{ V}, I_D = 2.5\text{ A}, V_{DS} = 50\text{ V}$ 2N6802 |             |      | 28.11 |      |

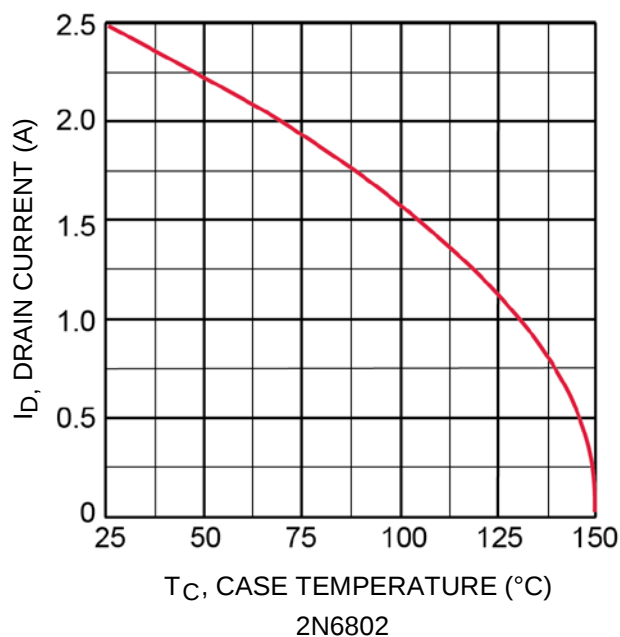
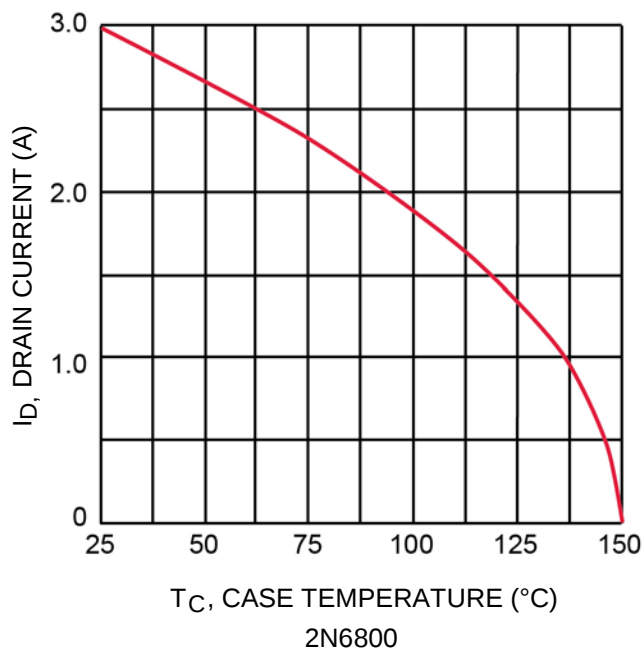
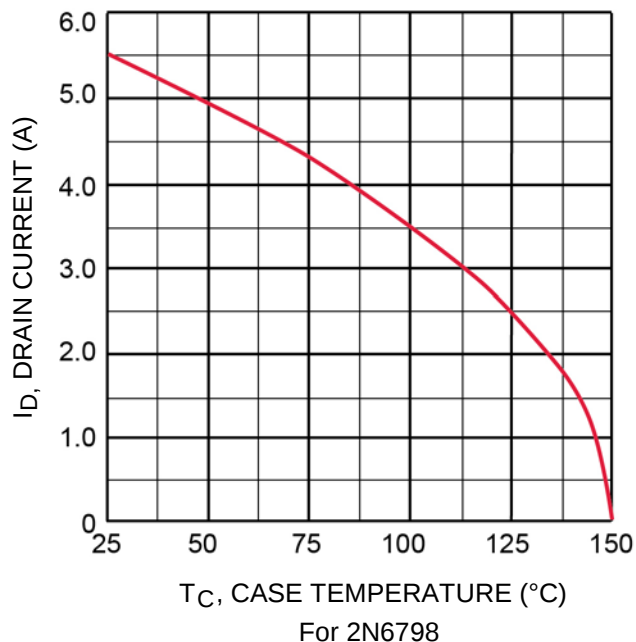
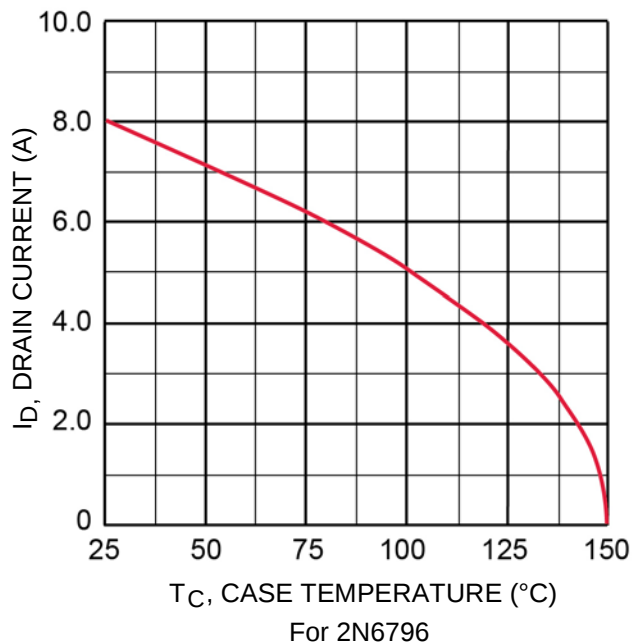
**SWITCHING CHARACTERISTICS**

| Parameters / Test Conditions                                                                       | Symbol       | Min. | Max. | Unit |
|----------------------------------------------------------------------------------------------------|--------------|------|------|------|
| Turn-on delay time                                                                                 | $t_{d(on)}$  |      |      |      |
| $I_D = 8.0\text{ A}, V_{GS} = +10\text{ V}, R_G = 7.5\text{ }\Omega, V_{DD} = 30\text{ V}$ 2N6796  |              |      |      | ns   |
| $I_D = 5.5\text{ A}, V_{GS} = +10\text{ V}, R_G = 7.5\text{ }\Omega, V_{DD} = 77\text{ V}$ 2N6798  |              |      | 30   |      |
| $I_D = 3.0\text{ A}, V_{GS} = +10\text{ V}, R_G = 7.5\text{ }\Omega, V_{DD} = 176\text{ V}$ 2N6800 |              |      |      |      |
| $I_D = 2.5\text{ A}, V_{GS} = +10\text{ V}, R_G = 7.5\text{ }\Omega, V_{DD} = 225\text{ V}$ 2N6802 |              |      |      |      |
| Rinse time                                                                                         | $t_r$        |      |      |      |
| $I_D = 8.0\text{ A}, V_{GS} = +10\text{ V}, R_G = 7.5\text{ }\Omega, V_{DD} = 30\text{ V}$ 2N6796  |              |      | 75   | ns   |
| $I_D = 5.5\text{ A}, V_{GS} = +10\text{ V}, R_G = 7.5\text{ }\Omega, V_{DD} = 77\text{ V}$ 2N6798  |              |      | 50   |      |
| $I_D = 3.0\text{ A}, V_{GS} = +10\text{ V}, R_G = 7.5\text{ }\Omega, V_{DD} = 176\text{ V}$ 2N6800 |              |      | 35   |      |
| $I_D = 2.5\text{ A}, V_{GS} = +10\text{ V}, R_G = 7.5\text{ }\Omega, V_{DD} = 225\text{ V}$ 2N6802 |              |      | 30   |      |
| Turn-off delay time                                                                                | $t_{d(off)}$ |      |      |      |
| $I_D = 8.0\text{ A}, V_{GS} = +10\text{ V}, R_G = 7.5\text{ }\Omega, V_{DD} = 30\text{ V}$ 2N6796  |              |      | 40   | ns   |
| $I_D = 5.5\text{ A}, V_{GS} = +10\text{ V}, R_G = 7.5\text{ }\Omega, V_{DD} = 77\text{ V}$ 2N6798  |              |      | 50   |      |
| $I_D = 3.0\text{ A}, V_{GS} = +10\text{ V}, R_G = 7.5\text{ }\Omega, V_{DD} = 176\text{ V}$ 2N6800 |              |      | 55   |      |
| $I_D = 2.5\text{ A}, V_{GS} = +10\text{ V}, R_G = 7.5\text{ }\Omega, V_{DD} = 225\text{ V}$ 2N6802 |              |      | 55   |      |
| Fall time                                                                                          | $t_f$        |      |      |      |
| $I_D = 8.0\text{ A}, V_{GS} = +10\text{ V}, R_G = 7.5\text{ }\Omega, V_{DD} = 30\text{ V}$ 2N6796  |              |      | 45   | ns   |
| $I_D = 5.5\text{ A}, V_{GS} = +10\text{ V}, R_G = 7.5\text{ }\Omega, V_{DD} = 77\text{ V}$ 2N6798  |              |      | 40   |      |
| $I_D = 3.0\text{ A}, V_{GS} = +10\text{ V}, R_G = 7.5\text{ }\Omega, V_{DD} = 176\text{ V}$ 2N6800 |              |      | 35   |      |
| $I_D = 2.5\text{ A}, V_{GS} = +10\text{ V}, R_G = 7.5\text{ }\Omega, V_{DD} = 225\text{ V}$ 2N6802 |              |      | 30   |      |
| Diode Reverse Recovery Time                                                                        | $t_{rr}$     |      |      |      |
| $di/dt \leq 100\text{ A}/\mu\text{s}, V_{DD} \leq 50\text{ V}, I_F = 8.0\text{ A}$ 2N6796          |              |      | 300  | ns   |
| $di/dt \leq 100\text{ A}/\mu\text{s}, V_{DD} \leq 50\text{ V}, I_F = 5.5\text{ A}$ 2N6798          |              |      | 500  |      |
| $di/dt \leq 100\text{ A}/\mu\text{s}, V_{DD} \leq 50\text{ V}, I_F = 3.0\text{ A}$ 2N6800          |              |      | 700  |      |
| $di/dt \leq 100\text{ A}/\mu\text{s}, V_{DD} \leq 50\text{ V}, I_F = 2.5\text{ A}$ 2N6802          |              |      | 900  |      |

# GRAPHS

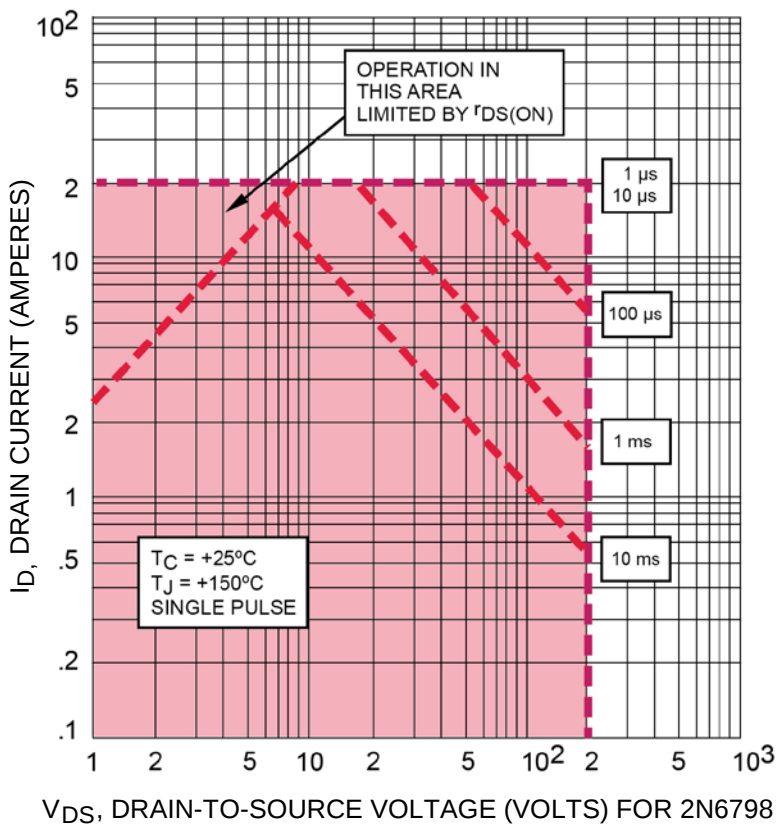
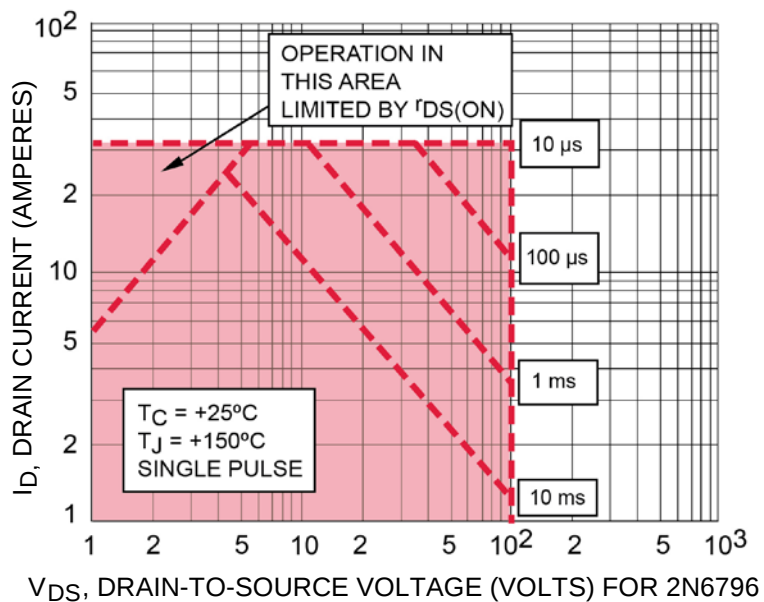


**FIGURE 1 – Normalized Transient Thermal Impedance**

**GRAPHS (continued)**
**FIGURE 2 – Maximum Drain Current versus Case Temperature Graphs**


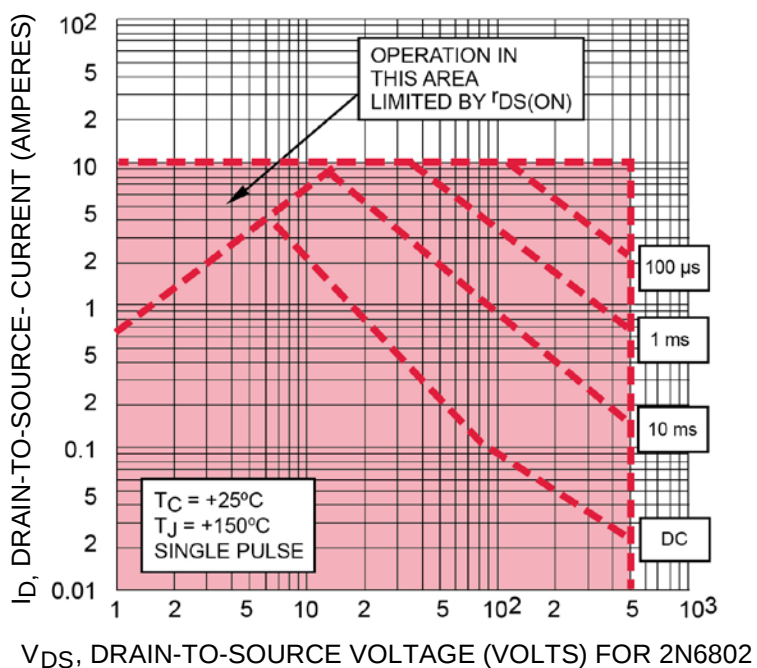
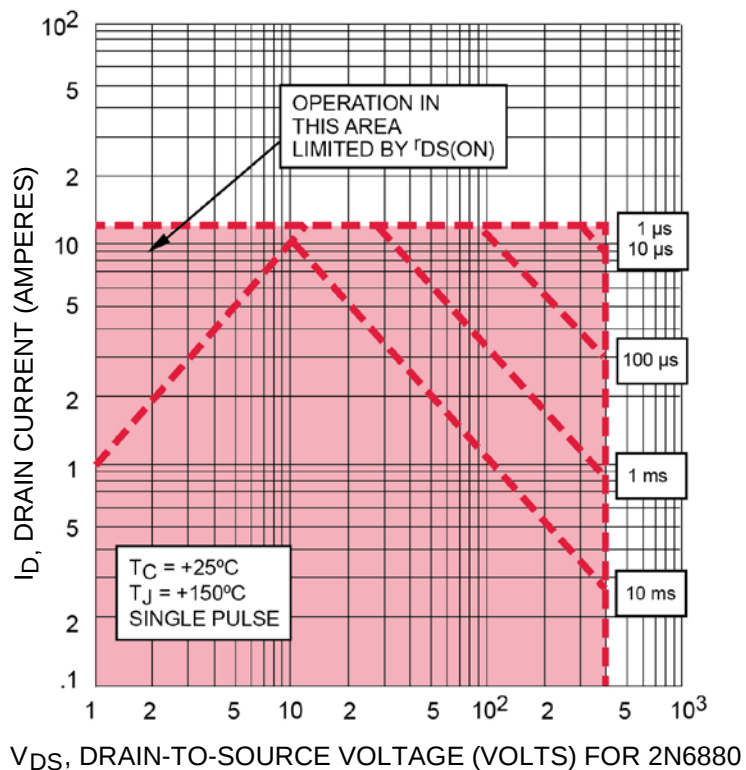
# GRAPHS (continued)

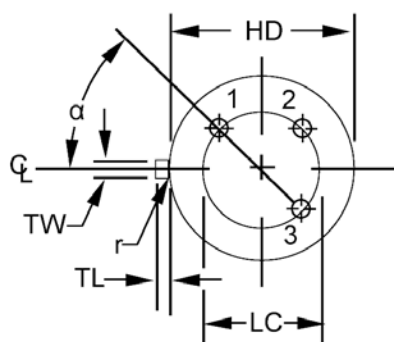
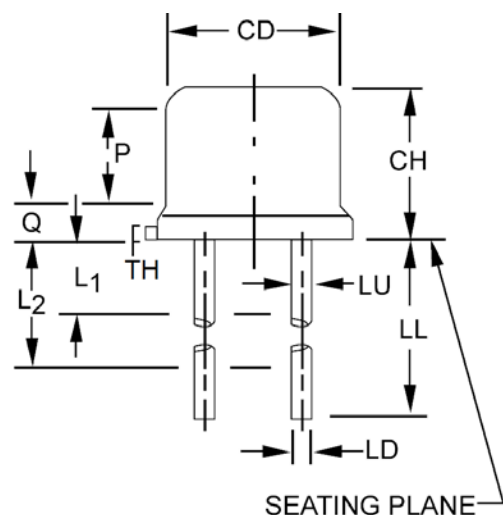
**FIGURE 3 – Maximum Safe Operating Area**



# GRAPHS (continued)

**FIGURE 3 – Maximum Safe Operating Area (continued)**



**PACKAGE DIMENSIONS**


| Symbol | Dimensions |       |             |       | Note |
|--------|------------|-------|-------------|-------|------|
|        | Inch       |       | Millimeters |       |      |
|        | Min        | Max   | Min         | Max   |      |
| CD     | 0.305      | 0.355 | 7.75        | 9.02  |      |
| CH     | 0.160      | .180  | 4.07        | 4.57  |      |
| HD     | 0.335      | 0.370 | 8.51        | 9.39  |      |
| LC     | 0.200 TP   |       | 5.08 TP     |       | 6    |
| LD     | 0.016      | 0.021 | 0.41        | 0.53  | 7, 8 |
| LL     | 0.500      | 0.750 | 12.70       | 19.05 | 7, 8 |
| LU     | 0.016      | 0.019 | 0.41        | 0.48  | 7, 8 |
| L1     |            | 0.050 |             | 1.27  | 7, 8 |
| L2     | 0.250      |       | 6.35        |       | 7, 8 |
| P      | .070       |       | 1.78        |       | 5    |
| Q      |            | 0.050 |             | 1.27  | 4    |
| TL     | 0.029      | 0.045 | 0.74        | 1.14  | 3    |
| TW     | 0.028      | 0.034 | 0.72        | 0.86  | 2    |
| TH     | .009       | .041  | 0.23        | 1.04  |      |
| r      |            | 0.010 |             | 0.25  | 9    |
| α      | 45° TP     |       | 45° TP      |       | 6    |

**NOTES:**

1. Dimensions are in inches. Millimeters are given for general information only.
2. Beyond radius (r) maximum, j shall be held for a minimum length of .011 (0.028 mm).
3. Dimension TL measured from maximum HD.
4. Outline in this zone is not controlled.
5. Dimension CD shall not vary more than .010 (0.25 mm) in zone P. This zone is controlled for automatic handling.
6. Leads at gauge plane .054 +.001, -.000 (1.37 +0.03, -0.00 mm) below seating plane shall be within .007 (0.18 mm) radius of true position (TP) at maximum material condition (MMC) relative to tab at MMC.
7. LU applies between L1 and L2. LD applies between L2 and L minimum. Diameter is uncontrolled in L1 and beyond LL minimum.
8. All three leads.
9. Radius (r) applies to both inside corners of tab.
10. Drain is electrically connected to the case.
11. In accordance with ASME Y14.5M, diameters are equivalent to  $\Phi$ x symbology.